



## Material Content Data Sheet



<b>Sales Product Name</b>		IPA70R750P7S		<b>Issued</b>		24. January 2018		
<b>MA#</b>		MA001672508						
<b>Package</b>		PG-TO220-3-312		<b>Weight*</b>		2055.81 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.365	0.07	0.07	664	664
leadframe	inorganic material	phosphorus	7723-14-0	0.285	0.01		138	
	non noble metal	iron	7439-89-6	0.949	0.05		461	
wire	non noble metal	copper	7440-50-8	947.445	46.08	46.14	460863	461462
	non noble metal	aluminium	7429-90-5	0.249	0.01	0.01	121	121
encapsulation	organic material	carbon black	1333-86-4	10.932	0.53		5318	
	plastics	epoxy resin	-	174.915	8.51		85084	
	inorganic material	silicondioxide	60676-86-0	907.373	44.14	53.18	441371	531773
leadfinish	non noble metal	tin	7440-31-5	11.095	0.54	0.54	5397	5397
solder	non noble metal	antimony	7440-36-0	0.120	0.01		58	
	noble metal	silver	7440-22-4	0.300	0.01		146	
	non noble metal	tin	7440-31-5	0.779	0.04	0.06	379	583
*deviation	< 10%			Sum in total:		100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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